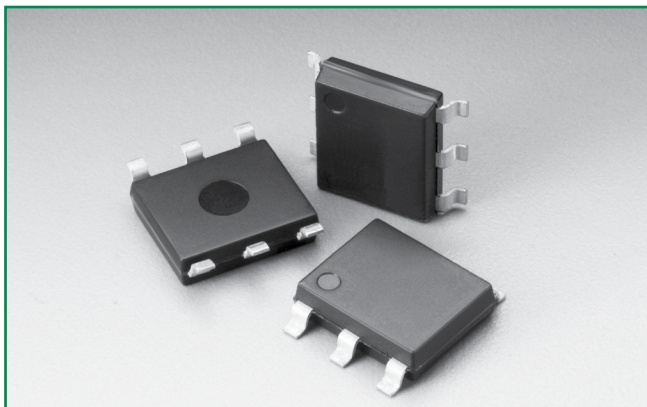


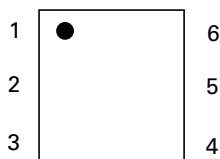
Battrax® Series - Dual Port Negative - MS-013



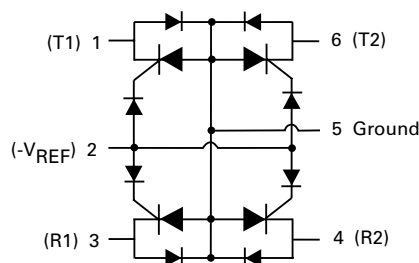
Agency Approvals

Agency	Agency File Number
	E133083

Pinout Designation



Schematic Symbol



Electrical Characteristics

Part Number	Marking	V_{DRM} @ $I_{DRM}=5\mu A$	V_S @ $100V/\mu s$	I_H	I_S	I_T	V_T @ $I_T=2.2$ Amps	V_F	Capacitance*	
		V min	V max	mA min	mA max	A max	V max	V max	pF min	pF max
B1101UC4Lxx	B1101UC4	$-V_{REF}I + I-1.2VI$	$-V_{REF}I + I-10VI$	100	100	2.2	4	5	30	200
B1161UC4Lxx	B1161UC4	$-V_{REF}I + I-1.2VI$	$-V_{REF}I + I-10VI$	160	100	2.2	4	5	30	200
B1201UC4Lxx	B1201UC4	$-V_{REF}I + I-1.2VI$	$-V_{REF}I + I-10VI$	200	100	2.2	4	5	30	200

Notes:

- Absolute maximum ratings measured at $T_A = 25^\circ C$ (unless otherwise noted).
- Components are uni-directional
- All electrical characteristics shown are defined from Tip (pin 1 & 6) to Ground (pin 5) and Ring (pin 3 & 4) to Ground (pin 5)
- Components are polarity sensitive and are not appropriate for positive ringing systems.

Description

The Dual Port Negative Battrax® Protection Thyristor Series are programmable SIDACtor® components designed to protect SLICs (Subscriber Line Interface Circuit) from damaging overvoltage transients.

Dual port protection is provided by a programmable device that is referenced to a negative voltage source while internal diodes provide protection from positive surge events.

Features and Benefits

- Low voltage overshoot
- Low on-state voltage
- Does not degrade surge capability after multiple surge events within limit.
- RoHS Compliant and Lead-Free
- Dual-port protection
- Gate trigger tracking device
- Fails short circuit when surged in excess of ratings
- Integrated diode for positive voltage surges
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21 Enhanced Level
- ITU K.20/21 Basic Level
- GR 1089 Intra-building
- IEC 61000-4-5 2nd edition
- YD/T 1082
- YD/T 993
- YD/T 950

Additional Information



Datasheet



Resources



Samples

- V_{REF} Max Value for the negative Battrax is -200 V.
- XX = Part Number Suffix: 'TP' (Tube Pack) or 'RP' (Reel Pack).

* Off-state capacitance (C_o) is measured across pins 1 & 5, 3 & 5, 4 & 5, and 6 & 5 at 1 MHz with a 2V bias.

Surge Ratings

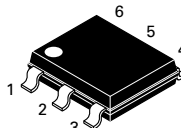
Series	I _{PP}									I _{TSM} 50/60 Hz	di/dt
	0.2/310 ¹ 0.5/700 ²	2/10 ¹ 2/10 ²	8/20 ¹ 1.2/50 ²	10/160 ¹ 10/160 ²	10/560 ¹ 10/560 ²	5/320 ¹ 9/720 ²	10/360 ¹ 10/360 ²	10/1000 ¹ 10/1000 ²	5/310 ¹ 10/700 ²		
	A min	A min	A min	A min	A min	A min	A min	A min	A min		
C	50	500	400	200	150	200	175	100	200	50	500

Notes:

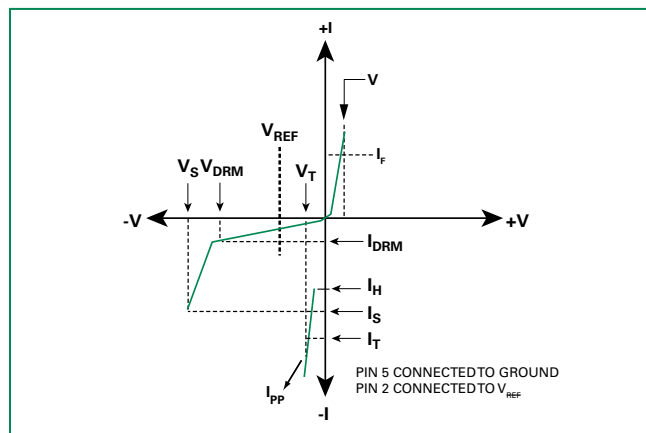
1 Current waveform in μs
2 Voltage waveform in μs

- Peak pulse current rating (I_{PP}) is repetitive and guaranteed for the life of the product that remains in thermal equilibrium.
- I_{PP} ratings applicable over temperature range of -40°C to +85°C (I_{PP} rating assumes V_{REF} equals -48 V)
- The component must initially be in thermal equilibrium with -40°C $\leq T_J \leq$ +150°C

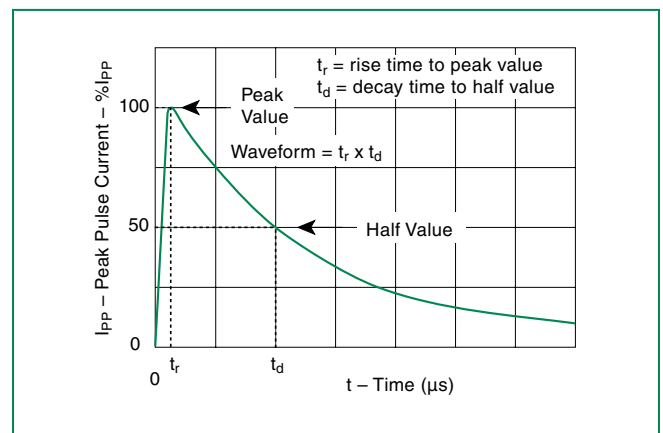
Thermal Considerations

Package	Symbol	Parameter	Value	Unit
Modified MS-013 6 	T_J	Operating Junction Temperature Range	-40 to +125	°C
	T_S	Storage Temperature Range	-65 to +150	°C
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	60	°C/W

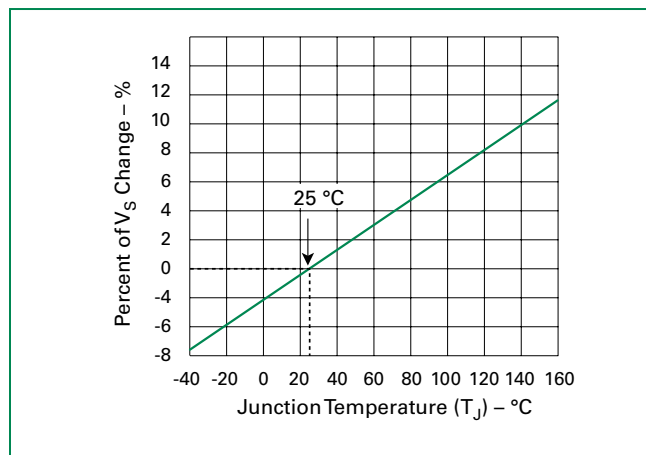
V-I Characteristics



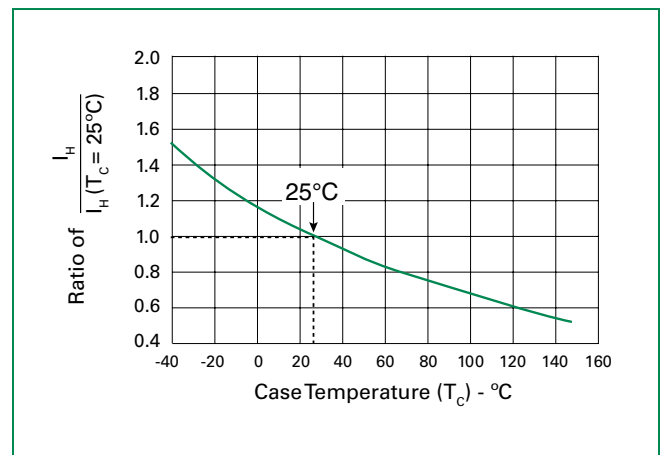
$t_r \times t_d$ Pulse Waveform



Normalized V_S Change vs. Junction Temperature

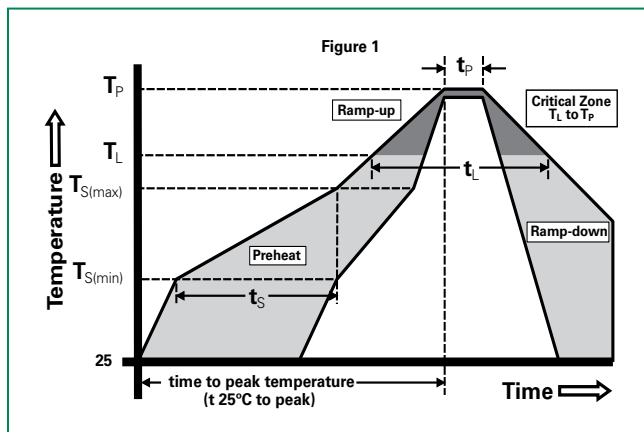


Normalized DC Holding Current vs. Case Temperature



Soldering Parameters

Reflow Condition		Pb-Free assembly (see Fig. 1)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max ($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/sec. Max.
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max.
Reflow	-Temperature (T_L) (Liquidus)	+217°C
	-Temperature (t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max.
Ramp-down Rate		6°C/sec. Max.
Time 25°C to Peak Temp (T_p)		8 min. Max.
Do not exceed		+260°C



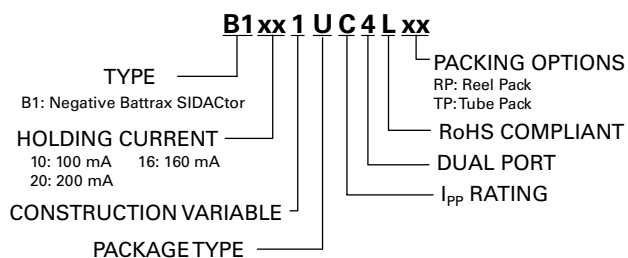
Physical Specifications

Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL Recognized epoxy meeting flammability classification V-0

Environmental Specifications

High Temp Voltage Blocking	80% Rated V_{DRM} (V_{DC} Peak) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101
Temp Cycling	-65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104
Biased Temp & Humidity	52 V_{DC} (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101
High Temp Storage	+150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101
Low Temp Storage	-65°C, 1008 hrs.
Thermal Shock	0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106
Autoclave (Pressure Cooker Test)	+121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/JEDEC, JESD22-A-102
Resistance to Solder Heat	+260°C, 30 secs. MIL-STD-750 (Method 2031)
Moisture Sensitivity Level	85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1

Part Numbering



Part Marking

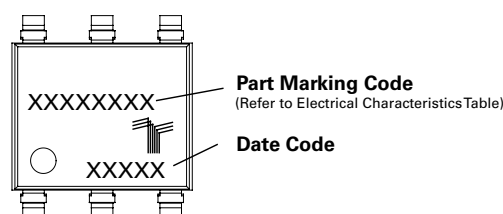


Figure 1: Dimensions and details of the 100-pin connector. The figure includes a top view, a side view, and a detail view of the 90-degree bend. The top view shows dimensions A, B, C, D, E, and F. The side view shows dimensions G, H, J, and K. The detail view shows the 90-degree bend with dimensions 4°, 96°, and K. The dimensions are in inches and millimeters.

Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.360	0.364	9.14	9.25
B	0.352	0.356	8.94	9.04
C	0.400	0.412	10.16	10.46
D	0.043	0.045	1.09	1.13
E	0.047	0.055	1.19	1.40
F	0.293	0.297	7.44	7.54
G	0.289	0.293	7.34	7.44
H	0.089	0.093	2.26	2.36
J	0.041	0.049	1.04	1.24
K	0.020	—	0.51	—
BSC*	0.133	0.143	3.38	3.63

Package Type	Description	Quantity	Added Suffix	Industry Standard
U	Modified MS-013 6-pin Tape and Reel Pack	1500	RP	EIA-481-D
	Modified MS-013 6-pin Tube Pack	500 (50 per tube)	TP	N/A

Technical drawing of a circular part with a rectangular feature. The drawing includes the following dimensions and labels:

- Top View:**
 - Circle diameter: 12.99 (330)
 - Rectangular feature width: 0.472 (12.0)
 - Rectangular feature height: 0.157 (4.0)
 - Distance from center to feature center: 0.512 (13.0) Arbor Hole Dia.
- Side View:**
 - Part thickness: 0.700 (17.8)
- Direction of Feed:** Indicated by an arrow pointing to the right.
- Note:** Dimensions are in inches (and millimeters)

Technical drawing of a tube with a message location detail. The main view shows a cross-section of the tube with dimensions in inches and millimeters. The dimensions are: .045 (1.14) for the top flange thickness, .165 (4.19) for the bottom flange thickness, .310 (7.87) for the top flange width, .108 (2.74) for the bottom flange width, .150 (3.81) for the inner diameter, .225 (5.72) for the outer diameter, and .525 (13.34) for the total width. A 90° angle is indicated for the top flange. The interior of the tube is labeled "Interior of the Tube". A detail view of the message location is shown on the right, with dimensions 20.000 ± .030 (508.00 ± 0.76) and .020 ± .005 (0.51 ± 0.13) WALL TYP. The detail view also shows a .110 (2.79) dimension for the message location. A feature control frame indicates a surface texture of .005 A. A dimension line points to the message location with the label "Message Location".

Dimensions are in inches
(and millimeters)

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Revised: 02/23/17